IGBT - Field Stop II / 4 Lead

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop II Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. In addition, this new device is packaged in a TO-247-4L package that provides significant reduction in Eon Losses compared to standard TO-247-3L package. The IGBT is well suited for UPS and solar applications. Incorporated into the device is a soft and fast co-packaged free wheeling diode with a low forward voltage.

Features

- Extremely Efficient Trench with Field Stop Technology
- $T_{Jmax} = 175^{\circ}C$
- Improved Gate Control Lowers Switching Losses
- Separate Emitter Drive Pin
- TO-247-4L for Minimal E_{on} Losses
- Optimized for High Speed Switching
- This is a Pb–Free Device

Typical Applications

- Solar Inverters
- Uninterruptible Power Supplies (UPS)
- Neutral Point Clamp Topology

ABSOLUTE MAXIMUM RATINGS

Rating Symbol Value Uni					
Rating	Symbol	Value	Unit		
Collector-emitter voltage	V _{CES}	650	V		
Collector current @ Tc = 25°C @ Tc = 100°C	Ι _C	160 50	A		
Diode Forward Current @ Tc = 25°C @ Tc = 100°C	l _F	160 50	A		
Diode Pulsed Current T _{PULSE} Limited by T _J Max	I _{FM}	160	A		
Pulsed collector current, T_{pulse} limited by T_{Jmax}	I _{CM}	160	A		
Gate-emitter voltage	V _{GE}	±20	V		
Transient gate–emitter voltage ($T_{PULSE} = 5 \ \mu s$, D < 0.10)		±30			
Power Dissipation @ Tc = 25°C @ Tc = 100°C	P _D	417 208	W		
Operating junction temperature range	TJ	-55 to +175	°C		
Storage temperature range	T _{stg}	-55 to +175	°C		
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD}	260	°C		

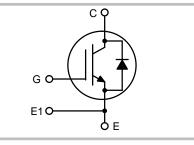
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

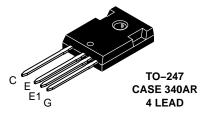


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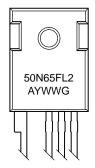
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50 A, 650 V $V_{CEsat} = 1.8 V$ $E_{on} = 0.48 \text{ mJ}$





MARKING DIAGRAM



50N65FL2 = Specific Device Code

- = Assembly Location А Υ
 - = Year

G

- WW = Work Week
 - = Pb-Free Package

ORDERING INFORMATION

Device	Package	Shipping
NGTB50N65FL2WAG	TO–247 (Pb–Free)	30 Units / Rail

THERMAL CHARACTERISTICS

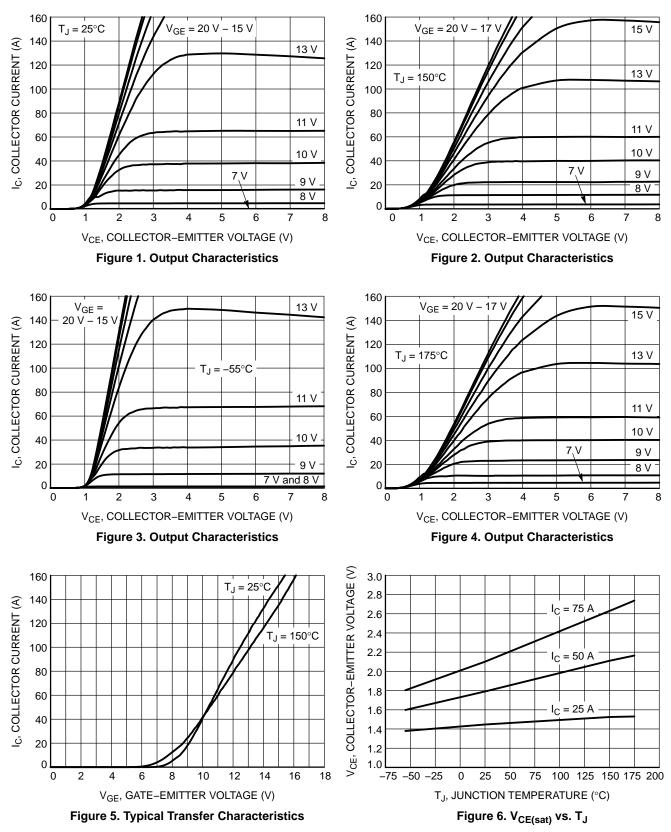
Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ ext{ heta}JC}$	0.36	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ ext{ heta}JC}$	0.62	°C/W
Thermal resistance junction-to-ambient	$R_{ hetaJA}$	40	°C/W

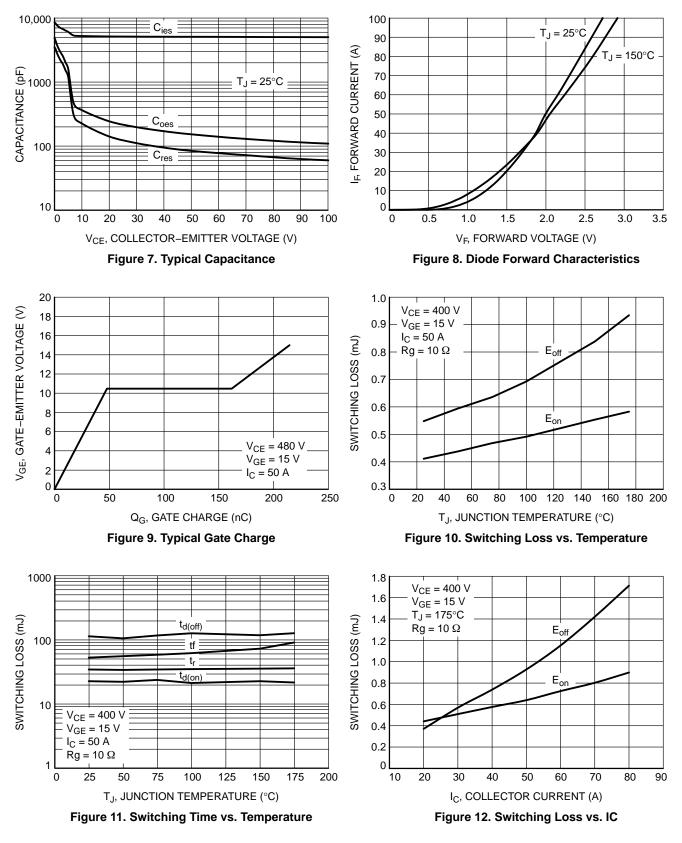
ELECTRICAL CHARACTERISTICS ($T_J = 25^{\circ}C$ unless otherwise specified)

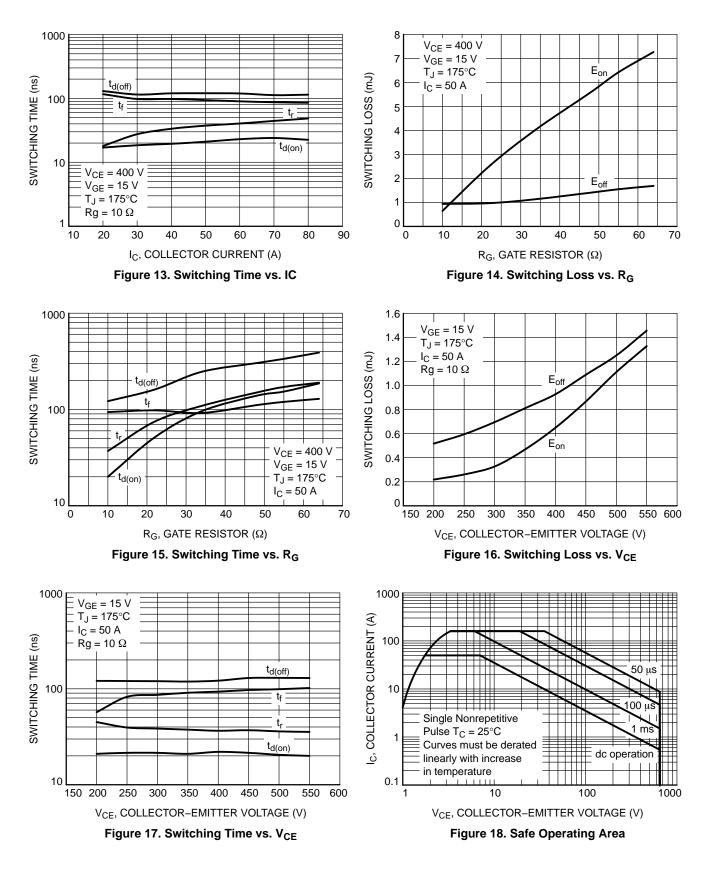
Parameter	Test Conditions	Symbol	Min	Тур	Мах	Unit
STATIC CHARACTERISTIC						
Collector-emitter breakdown voltage, gate-emitter short-circuited	$V_{GE} = 0 \text{ V}, I_{C} = 500 \mu\text{A}$	V _{(BR)CES}	650	-	-	V
Collector-emitter saturation voltage	V_{GE} = 15 V, I _C = 50 A V_{GE} = 15 V, I _C = 50 A, T _J = 175°C	V _{CEsat}	-	1.80 2.17	2.00	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_C = 350 \mu\text{A}$	V _{GE(th)}	4.5	5.5	6.5	V
Collector-emitter cut-off current, gate- emitter short-circuited	$V_{GE} = 0 V, V_{CE} = 650 V$ $V_{GE} = 0 V, V_{CE} = 650 V, T_{J} = 175^{\circ}C$	ICES		- 5.5	0.3 -	mA
Gate leakage current, collector-emitter short-circuited	$V_{GE} = 20 \text{ V}$, $V_{CE} = 0 \text{ V}$	I _{GES}	-	-	200	nA
DYNAMIC CHARACTERISTIC						
Input capacitance		C _{ies}	-	5160	-	pF
Output capacitance	V_{CE} = 20 V, V_{GE} = 0 V, f = 1 MHz	C _{oes}	-	244	-	
Reverse transfer capacitance	1	C _{res}	_	141	-	
Gate charge total		Qg	-	215	-	nC
Gate to emitter charge	V_{CE} = 480 V, I _C = 50 A, V _{GE} = 15 V	Q _{ge}	-	48	-	
Gate to collector charge		Q _{gc}	-	116	-	
SWITCHING CHARACTERISTIC, INDUC	TIVE LOAD					
Turn-on delay time		t _{d(on)}	_	23	_	ns
Rise time	1	t _r	_	35	-	
Turn-off delay time	$T_{J} = 25^{\circ}C$ $V_{CC} = 400 \text{ V}, \text{ I}_{C} = 50 \text{ A}$ $R_{g} = 10 \Omega$ $V_{GE} = 15 \text{ V}$	t _{d(off)}	-	123	-	
Fall time		t _f	-	54	-	
Turn-on switching loss		Eon	-	0.42	-	mJ
Turn-off switching loss		E _{off}	_	0.55	-	
Total switching loss	1	E _{ts}	_	0.97	-	
Turn-on delay time		t _{d(on)}	_	22	-	ns
Rise time	1	t _r	_	38	-	
Turn-off delay time	T _J = 175°C	t _{d(off)}	_	130	-	
Fall time	$V_{CC} = 400 \text{ V}, \text{ I}_{C} = 50 \text{ A}$ $R_{g} = 10 \Omega$	t _f	_	93	-	
Turn-on switching loss	$V_{GE} = 10.22$ $V_{GE} = 15 V$	Eon	_	0.58	-	mJ
Turn-off switching loss		E _{off}	_	0.92	-	
Total switching loss		E _{ts}	-	1.50	-	
DIODE CHARACTERISTIC	•					
Forward voltage	$V_{GE} = 0 V$, $I_F = 50 A$ $V_{GE} = 0 V$, $I_F = 50 A$, $T_J = 175^{\circ}C$	V _F		2.10 2.20	2.60 -	V
Reverse recovery time	$T_J = 25^{\circ}C$ $I_F = 50 \text{ A}, V_R = 400 \text{ V}$ $di_F/dt = 200 \text{ A}/\mu\text{s}$	t _{rr}	-	94	-	ns
Reverse recovery charge		Q _{rr}	_	0.36	-	μC
Reverse recovery current		I _{rrm}	-	6.5	-	А
Reverse recovery time	T _{.1} = 175°C	t _{rr}	_	170	-	ns
Reverse recovery charge	$I_{J} = 175^{\circ}C$ $I_{F} = 50 \text{ A}, V_{R} = 400 \text{ V}$ $di_{F}/dt = 200 \text{ A}/\mu\text{s}$	Q _{rr}	-	1.40	-	μC
Reverse recovery current		I _{rrm}	_	13	-	A

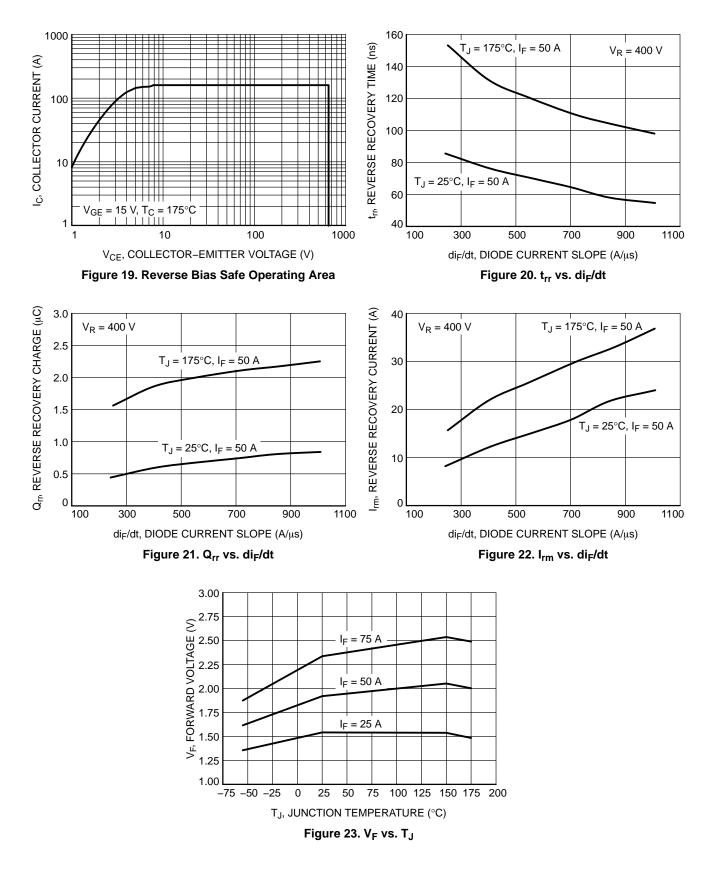
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

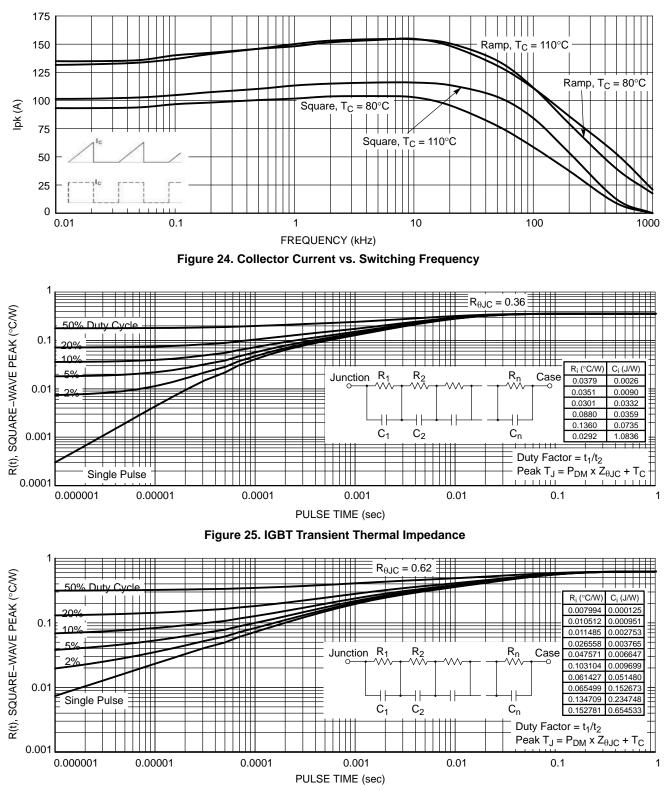














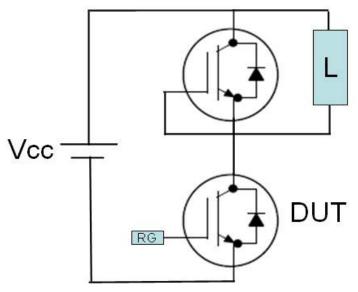
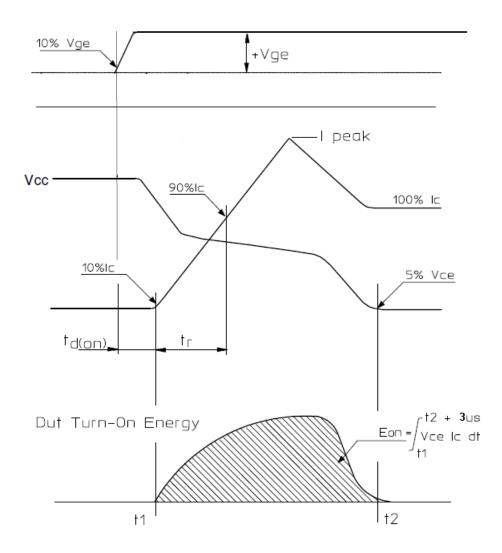
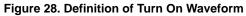


Figure 27. Test Circuit for Switching Characteristics





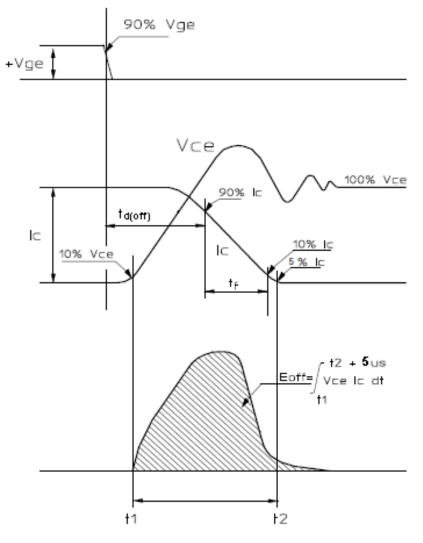
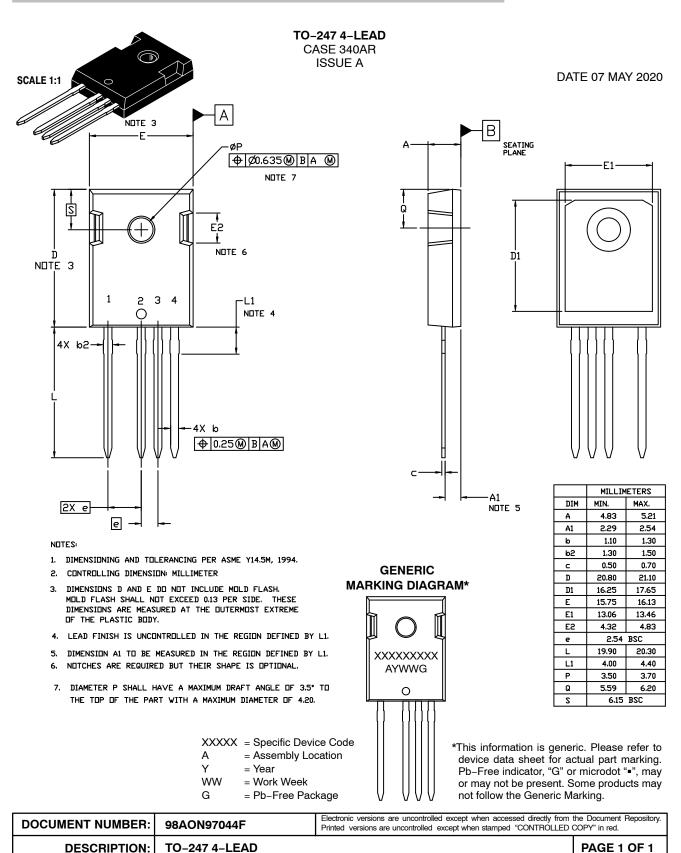


Figure 29. Definition of Turn Off Waveform

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS





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